

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of

Takaaki SASAKI

[Group Art Unit: 2822]

New Divisional of Serial No. 09/062,720

[Examiner: T. M. Arroyo]

Filed: October 13, 2000

For: SEMICONDUCTOR DEVICE, SEMICONDUCTOR PACKAGE FOR USE THEREIN, AND MANUFACTURING METHOD THEREOF

#41a
12-3000
Payton

PRELIMINARY AMENDMENT

Honorable Assistant Commission of Patents and Trademarks,
Washington, D.C. 20231

Sir:

Preliminary to the examination of the above-identified application, please enter the following amendments and consider the following remarks:

In the Abstract

Kindly amend the Abstract of the Disclosure as follows:

Line 2, change "comprised of" to -- includes -- .

~~Line 3, change "element" to -- chip -- .~~

Line 4, change "through" to -- elongate opening -- .

Line 5, delete “hall”; and change “element” to -- chip -- .